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#### What is "Embedded - Microcontrollers"?

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## Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Active
Core Processor	AVR
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	36
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	·
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	1.62V ~ 3.6V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-VFQFN Exposed Pad
Supplier Device Package	48-QFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/atmel/atuc64l4u-zaur

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# 7.7.8 Memory Address Reload Register

Name:	MARR
Access Type:	Read/Write
Offset:	0x00C + n*0x040
Reset Value:	0x00000000

MARV[31:24]         23       22       21       20       19       18       17       16         MARV[23:16]         15       14       13       12       11       10       9       8         MARV[15:8]         7       6       5       4       3       2       1       0	31	30	29	28	27	26	25	24
MARV[23:16] 15 14 13 12 11 10 9 8 MARV[15:8]				MARV	[31:24]			
MARV[23:16]         15       14       13       12       11       10       9       8         MARV[15:8]								
15 14 13 12 11 10 9 8 MARV[15:8]	23	22	21	20	19	18	17	16
MARV[15:8]		MARV[23:16]						
MARV[15:8]								
	15	14	13	12	11	10	9	8
7 6 5 4 3 2 1 0	MARV[15:8]							
7         6         5         4         3         2         1         0								
	7	6	5	4	3	2	1	0
MARV[7:0]		MARV[7:0]						

# • MARV: Memory Address Reload Value

Reload Value for the MAR register. This value will be loaded into MAR when TCR reaches zero if the TCRR register has a non-zero value.

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7.7.24 Perfor Name:	mance Cha PRDAT	n <b>nel 1 Read D</b> a ⊺A1	ata Cycles				
Access Type:	Read-o	only					
Offset:	0x81C						
Reset Value:	0x0000	00000					
31	30	29	28	27	26	25	24
			DATA[	[31:24]			
23	22	21	20	19	18	17	16
	DATA[23:16]						
15	14	13	12	11	10	9	8
DATA[15:8]							
7	6	5	4	3	2	1	0
DATA[7:0]							

DATA: Data Cycles Counted Since Last Reset

Clock cycles are counted using the CLK\_PDCA\_HSB clock

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8.7.2.12	Endpo	oint n Status Clear Register
Register N	lame:	UESTAnCLR, n in [06]
Access Ty	pe:	Write-Only
Offset:		0x0160 + (n * 0x04)
Reset Valu	le:	0x0000000

31	30	29	28	27	26	25	24
-	-	-	-	-	-	-	-
23	22	21	20	19	18	17	16
-	-	-	-	-	-	-	-
15	14	13	12	11	10	9	8
-	-	-	-	RAMACERIC	-	-	-
7	6	5	4	3	2	1	0
-	STALLEDIC/ CRCERRIC	-	NAKINIC	NAKOUTIC	RXSTPIC/ ERRORFIC	RXOUTIC	TXINIC

Writing a zero to a bit in this register has no effect.

Writing a one to a bit in this register will clear the corresponding bit in UESTA.

These bits always read as zero.

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# 9. Flash Controller (FLASHCDW)

Rev: 1.2.0.0

# 9.1 Features

- Controls on-chip flash memory
- Supports 0 and 1 wait state bus access
- · Buffers reducing penalty of wait state in sequential code or loops
- Allows interleaved burst reads for systems with one wait state, outputting one 32-bit word per clock cycle for sequential reads
- Secure State for supporting FlashVault technology
- 32-bit HSB interface for reads from flash and writes to page buffer
- 32-bit PB interface for issuing commands to and configuration of the controller
- Flash memory is divided into 16 regions can be individually protected or unprotected
- Additional protection of the Boot Loader pages
- · Supports reads and writes of general-purpose Non Volatile Memory (NVM) bits
- Supports reads and writes of additional NVM pages
- Supports device protection through a security bit
- Dedicated command for chip-erase, first erasing all on-chip volatile memories before erasing flash and clearing security bit

# 9.2 Overview

The Flash Controller (FLASHCDW) interfaces the on-chip flash memory with the 32-bit internal HSB bus. The controller manages the reading, writing, erasing, locking, and unlocking sequences.

# 9.3 **Product Dependencies**

In order to use this module, other parts of the system must be configured correctly, as described below.

## 9.3.1 Power Management

If the CPU enters a sleep mode that disables clocks used by the FLASHCDW, the FLASHCDW will stop functioning and resume operation after the system wakes up from sleep mode.

## 9.3.2 Clocks

The FLASHCDW has two bus clocks connected: One High Speed Bus clock (CLK\_FLASHCDW\_HSB) and one Peripheral Bus clock (CLK\_FLASHCDW\_PB). These clocks are generated by the Power Manager. Both clocks are enabled at reset, and can be disabled by writing to the Power Manager. The user has to ensure that CLK\_FLASHCDW\_HSB is not turned off before reading the flash or writing the pagebuffer and that CLK\_FLASHCDW\_PB is not turned off before accessing the FLASHCDW configuration and control registers. Failing to do so may deadlock the bus.

## 9.3.3 Interrupts

The FLASHCDW interrupt request lines are connected to the interrupt controller. Using the FLASHCDW interrupts requires the interrupt controller to be programmed first.

The page buffer is not automatically reset after a page write. The programmer should do this manually by issuing the Clear Page Buffer flash command. This can be done after a page write, or before the page buffer is loaded with data to be stored to the flash page.

# 9.5 Flash Commands

The FLASHCDW offers a command set to manage programming of the flash memory, locking and unlocking of regions, and full flash erasing. See Section 9.8.2 for a complete list of commands.

To run a command, the CMD field in the Flash Command Register (FCMD) has to be written with the command number. As soon as the FCMD register is written, the FRDY bit in the Flash Status Register (FSR) is automatically cleared. Once the current command is complete, the FSR.FRDY bit is automatically set. If an interrupt has been enabled by writing a one to FCR.FRDY, the interrupt request line of the Flash Controller is activated. All flash commands except for Quick Page Read (QPR) and Quick User Page Read (QPRUP) will generate an interrupt request upon completion if FCR.FRDY is one.

Any HSB bus transfers attempting to read flash memory when the FLASHCDW is busy executing a flash command will be stalled, and allowed to continue when the flash command is complete.

After a command has been written to FCMD, the programming algorithm should wait until the command has been executed before attempting to read instructions or data from the flash or writing to the page buffer, as the flash will be busy. The waiting can be performed either by polling the Flash Status Register (FSR) or by waiting for the flash ready interrupt. The command written to FCMD is initiated on the first clock cycle where the HSB bus interface in FLASHCDW is IDLE. The user must make sure that the access pattern to the FLASHCDW HSB interface contains an IDLE cycle so that the command is allowed to start. Make sure that no bus masters such as DMA controllers are performing endless burst transfers from the flash. Also, make sure that the CPU does not perform endless burst transfers for command completion. This polling will result in an access pattern with IDLE HSB cycles.

All the commands are protected by the same keyword, which has to be written in the eight highest bits of the FCMD register. Writing FCMD with data that does not contain the correct key and/or with an invalid command has no effect on the flash memory; however, the PROGE bit is set in the Flash Status Register (FSR). This bit is automatically cleared by a read access to the FSR register.

Writing a command to FCMD while another command is being executed has no effect on the flash memory; however, the PROGE bit is set in the Flash Status Register (FSR). This bit is automatically cleared by a read access to the FSR register.

If the current command writes or erases a page in a locked region, or a page protected by the BOOTPROT fuses, the command has no effect on the flash memory; however, the LOCKE bit is set in the FSR register. This bit is automatically cleared by a read access to the FSR register.

## 9.5.1 Write/Erase Page Operation

Flash technology requires that an erase must be done before programming. The entire flash can be erased by an Erase All command. Alternatively, pages can be individually erased by the Erase Page command.

The User page can be written and erased using the mechanisms described in this chapter.



#### • FSZ: Flash Size

The size of the flash. Not all device families will provide all flash sizes indicated in the table.

FSZ	Flash Size	FSZ	Flash Size
0	4 Kbyte	8	192 Kbyte
1	8 Kbyte	9	256 Kbyte
2	16 Kbyte	10	384 Kbyte
3	32 Kbyte	11	512 Kbyte
4	48 Kbyte	12	768 Kbyte
5	64 Kbyte	13	1024 Kbyte
6	96 Kbyte	14	2048 Kbyte
7	128 Kbyte	15	Reserved

# Table 9-10.Flash Size

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# 14.6.10 DFLLn Configuration Register

Name:	DFLLnCONF
Access Type:	Read/Write
Reset Value:	0x00000000

31	30	29	28	27	26	25	24
			COAR	SE[7:0]			
23	22	21	20	19	18	17	16
-	-	-	-	-	-	-	FINE[8]
15	14	13	12	11	10	9	8
	FINE[7:0]						
7	6	5	4	3	2	1	0
-	QLEN	CCEN	-	LLAW	DITHER	MODE	EN

#### • COARSE: Coarse Calibration Value

Set the value of the coarse calibration register. If in closed loop mode, this field is Read-only.

#### • FINE: FINE Calibration Value

Set the value of the fine calibration register. If in closed loop mode, this field is Read-only.

#### • QLEN: Quick Lock Enable

- 0: Quick Lock is disabled.
- 1: Quick Lock is enabled.

# • CCEN: Chill Cycle Enable

- 0: Chill Cycle is disabled.
- 1: Chill Cycle is enabled.

## • LLAW: Lose Lock After Wake

- 0: Locks will not be lost after waking up from sleep modes.
- 1: Locks will be lost after waking up from sleep modes where the DFLL clock has been stopped.

## • DITHER: Enable Dithering

- 0: The fine LSB input to the VCO is constant.
- 1: The fine LSB input to the VCO is dithered to achieve sub-LSB approximation to the correct multiplication ratio.
- MODE: Mode Selection
  - 0: The DFLL is in open loop operation.
  - 1: The DFLL is in closed loop operation.
- EN: Enable
  - 0: The DFLL is disabled.
  - 1: The DFLL is enabled.

Note that this register is protected by a lock. To write to this register the UNLOCK register has to be written first. Please refer to the UNLOCK register description for details.

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# 14.6.15 DFLLn Synchronization Register

Name:	DFLLnSYNC
Access Type:	Write-only
Reset Value:	0x00000000

31	30	29	28	27	26	25	24
-	-	-	-	-	-	-	-
23	22	21	20	19	18	17	16
-	-	-	-	-	-	-	-
15	14	13	12	11	10	9	8
-	-	-	-	-	-	-	-
7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	SYNC

#### • SYNC: Synchronization

To be able to read the current value of DFLLnCONF or DFLLnRATIO in closed-loop mode, this bit should be written to one. The updated value is available in DFLLnCONF and DFLLnRATIO when PCLKSR.DFLLnRDY is set.

# 14.6.44 Generic Clock Version Register

Name:	GCLKVERSION
Access Type:	Read-only
Offset:	0x03F8
Reset Value:	-

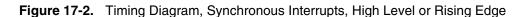
31	30	29	28	27	26	25	24
-	-	-	-	-	-	-	-
23	22	21	20	19	18	17	16
-	-	-	-		VAR	IANT	
15	14	13	12	11	10	9	8
-	-	-	-		VERSIC	DN[11:8]	
7	6	5	4	3	2	1	0
			VERSI	ON[7:0]			
L							

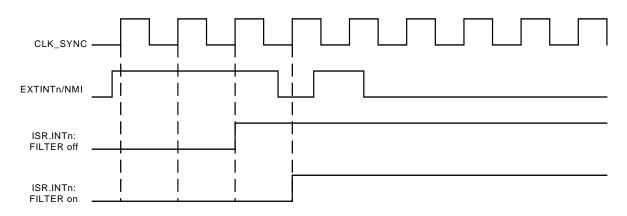
# • VARIANT: Variant number

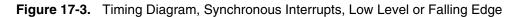
Reserved. No functionality associated.

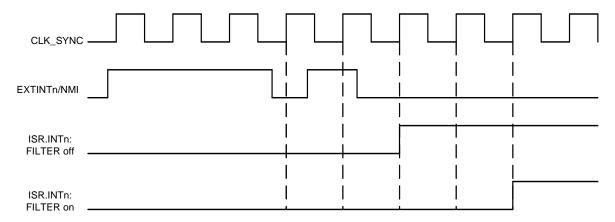
# • VERSION: Version number

Version number of the module. No functionality associated.









# 17.6.3 Non-Maskable Interrupt

The NMI supports the same features as the external interrupts, and is accessed through the same registers. The description in Section 17.6.1 should be followed, accessing the NMI bit instead of the INTn bits.

The NMI is non-maskable within the CPU in the sense that it can interrupt any other execution mode. Still, as for the other external interrupts, the actual NMI input can be enabled and disabled by accessing the registers in the EIC.

# 17.6.4 Asynchronous Interrupts

Each external interrupt can be made asynchronous by writing a one to INTn in the ASYNC register. This will route the interrupt signal through the asynchronous path of the module. All edge interrupts will be interpreted as level interrupts and the filter is disabled. If an interrupt is configured as edge triggered interrupt in asynchronous mode, a zero in EDGE.INTn will be interpreted as low level, and a one in EDGE.INTn will be interpreted as high level.

EIC\_WAKE will be set immediately after the source triggers the interrupt, while the corresponding bit in ISR and the interrupt to the interrupt controller will be set on the next rising edge of CLK\_SYNC. Please refer to Figure 17-4 on page 369 for details.



# 17.7 User Interface

 Table 17-2.
 EIC Register Memory Map

Offset	Register	Register Name	Access	Reset
0x000	Interrupt Enable Register	IER	Write-only	0x0000000
0x004	Interrupt Disable Register	IDR	Write-only	0x0000000
0x008	Interrupt Mask Register	IMR	Read-only	0x0000000
0x00C	Interrupt Status Register	ISR	Read-only	0x0000000
0x010	Interrupt Clear Register	ICR	Write-only	0x0000000
0x014	Mode Register	MODE	Read/Write	0x0000000
0x018	Edge Register	EDGE	Read/Write	0x0000000
0x01C	Level Register	LEVEL	Read/Write	0x0000000
0x020	Filter Register	FILTER	Read/Write	0x0000000
0x024	Test Register	TEST	Read/Write	0x0000000
0x028	Asynchronous Register	ASYNC	Read/Write	0x0000000
0x030	Enable Register	EN	Write-only	0x0000000
0x034	Disable Register	DIS	Write-only	0x0000000
0x038	Control Register	CTRL	Read-only	0x0000000
0x3FC	Version Register	VERSION	Read-only	_ (1)

Note: 1. The reset value is device specific. Please refer to the Module Configuration section at the end of this chapter.

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# 17.7.5 Interrupt Clear Register

Name:	ICR
Access Type:	Write-only
Offset:	0x010
Reset Value:	0x0000000

31	30	29	28	27	26	25	24
-	INT30	INT29	INT28	INT27	INT26	INT25	INT24
23	22	21	20	19	18	17	16
INT23	INT22	INT21	INT20	INT19	INT18	INT17	INT16
15	14	13	12	11	10	9	8
INT15	INT14	INT13	INT12	INT11	INT10	INT9	INT8
7	6	5	4	3	2	1	0
INT7	INT6	INT5	INT4	INT3	INT2	INT1	NMI

#### • INTn: External Interrupt n

Writing a zero to this bit has no effect.

Writing a one to this bit will clear the corresponding bit in ISR.

Please refer to the Module Configuration section for the number of external interrupts.

#### • NMI: Non-Maskable Interrupt

Writing a zero to this bit has no effect.

Writing a one to this bit will clear the corresponding bit in ISR.

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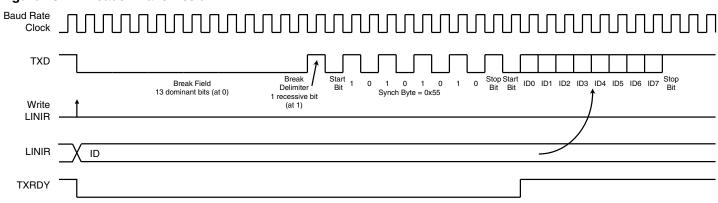
customizable response data lengths, and requires minimal CPU resources. Writing 0xA (master) or 0xB (slave) to MR.MODE enables this mode.

- 20.6.5.1 Modes of operation Changing LIN mode after initial configuration has to be followed by a transceiver software reset in order to avoid unpredictable behavior.
- 20.6.5.2 Receiver and Transmitter Control See Section "20.6.2" on page 439.
- 20.6.5.3 Baud Rate Configuration The LIN nodes baud rate is configured in the Baud Rate Generator Register (BRGR), See Section "20.6.1.1" on page 437.
- 20.6.5.4 Character Transmission and Reception See "Transmitter Operations" on page 440, and "Receiver Operations" on page 442.

# 20.6.5.5 Header Transmission (Master Node Configuration)

All LIN frames start with a header sent by the master. As soon as the identifier has been written to the Identifier Character field in the LIN Identifier Register (LINIR.IDCHR), TXRDY is cleared and the header is sent. The header consists of a Break, Sync, and Identifier field. TXRDY is set when the identifier has been transferred into the transmitters shift register.

The Break field consists of 13 dominant bits, the break, and one recessive bit, the break delimiter. The Sync field is the character 0x55. The Identifier field contains the Identifier as written to IDCHR. The identifier parity bits can be generated automatically (see Section 20.6.5.8).



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# Figure 20-21. Header Transmission

#### 20.6.5.6 Header Reception (Slave Node Configuration)

The USART stays idle until it detects a break field, consisting of at least 11 consecutive dominant bits (zeroes) on the bus. A received break will set the Lin Break bit (CSR.LINBK). The Sync field is used to synchronize the baud rate (see Section 20.6.5.7). IDCHR is updated and the LIN Identifier bit (CSR.LINID) is set when the Identifier has been received. The Identifier parity bits can be automatically checked (see Section 20.6.5.8). Writing a one to RSTSTA will clear LINBK and LINID.

# • BITS: Bits Per Transfer

The BITS field determines the number of data bits transferred. Reserved values should not be used.

BITS	Bits Per Transfer
0000	8
0001	9
0010	10
0011	11
0100	12
0101	13
0110	14
0111	15
1000	16
1001	4
1010	5
1011	6
1100	7
1101	Reserved
1110	Reserved
1111	Reserved

# CSAAT: Chip Select Active After Transfer

1: The Peripheral Chip Select does not rise after the last transfer is achieved. It remains active until a new transfer is requested on a different chip select.

0: The Peripheral Chip Select Line rises as soon as the last transfer is achieved.

# • CSNAAT: Chip Select Not Active After Transfer (Ignored if CSAAT = 1)

0: The Peripheral Chip Select does not rise between two transfers if the TDR is reloaded before the end of the first transfer and if the two transfers occur on the same Chip Select.

1: The Peripheral Chip Select rises systematically between each transfer performed on the same slave for a minimal duration of:

 $\frac{DLYBCS}{CLKSPI}$  (if DLYBCT field is different from 0)

 $\frac{DLYBCS + 1}{CLKSPI}$  (if DLYBCT field equals 0)

# • NCPHA: Clock Phase

1: Data is captured after the leading (inactive-to-active) edge of SPCK and changed on the trailing (active-to-inactive) edge of SPCK.

0: Data is changed on the leading (inactive-to-active) edge of SPCK and captured after the trailing (active-to-inactive) edge of SPCK.

NCPHA determines which edge of SPCK causes data to change and which edge causes data to be captured. NCPHA is used with CPOL to produce the required clock/data relationship between master and slave devices.

# CPOL: Clock Polarity

1: The inactive state value of SPCK is logic level one.

0: The inactive state value of SPCK is logic level zero.

22.9.1 Con Name:	t <b>rol Register</b> CR						
Access Type:	Write-c	only					
Offset:	0x00						
Reset Value:	0x0000	00000					
31	30	29	28	27	26	25	24
-	-	-	-	-	-	-	-
23	22	21	20	19	18	17	16
-	-	-	-	-	-	-	-
15	14	13	12	11	10	9	8
-	-	-	-	-	-	-	STOP
7	6	5	4	3	2	1	0
SWRST	-	SMDIS	SMEN	-	-	MDIS	MEN

#### • STOP: Stop the Current Transfer

Writing a one to this bit terminates the current transfer, sending a STOP condition after the shifter has become idle. If there are additional pending transfers, they will have to be explicitly restarted by software after the STOP condition has been successfully sent.

Writing a zero to this bit has no effect.

#### • SWRST: Software Reset

If the TWIM master interface is enabled, writing a one to this bit resets the TWIM. All transfers are halted immediately, possibly violating the bus semantics.

If the TWIM master interface is not enabled, it must first be enabled before writing a one to this bit.

Writing a zero to this bit has no effect.

# • SMDIS: SMBus Disable

Writing a one to this bit disables SMBus mode.

Writing a zero to this bit has no effect.

# • SMEN: SMBus Enable

Writing a one to this bit enables SMBus mode.

Writing a zero to this bit has no effect.

#### • MDIS: Master Disable

Writing a one to this bit disables the master interface.

Writing a zero to this bit has no effect.

#### • MEN: Master Enable

Writing a one to this bit enables the master interface. Writing a zero to this bit has no effect.

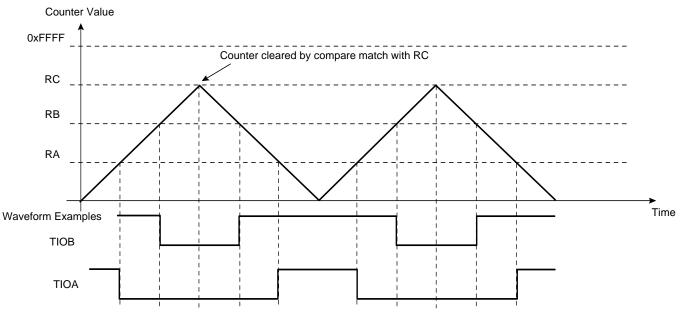
# 26.6.3.5 WAVSEL = 3

When CMRn.WAVSEL is three, the value of CVn is incremented from zero to RC. Once RC is reached, the value of CVn is decremented to zero, then re-incremented to RC and so on. See Figure 26-12 on page 656.

A trigger such as an external event or a software trigger can modify CVn at any time. If a trigger occurs while CVn is incrementing, CVn then decrements. If a trigger is received while CVn is decrementing, CVn then increments. See Figure 26-13 on page 657.

RC Compare can stop the counter clock (CMRn.CPCSTOP = 1) and/or disable the counter clock (CMRn.CPCDIS = 1).





# 31.7.13Status RegisterName:SRAccess Type:Read-onlyOffset:0x3CReset Value:0x0000000

31	30	29	28	27	26	25	24
-	-	-	-	-	-	-	-
23	22	21	20	19	18	17	16
DMATSC	-	-	-	-	-	DMATSR	DMATSW
15	14	13	12	11	10	9	8
-	-	-	-	-	-	ACQDONE	ACREADY
7	6	5	4	3	2	1	0
-	-	-	MBLREQ	ATSTATE	ATSC	ATCAL	ENABLED

#### • DMATSC: DMATouch Sensor State Change

0: No change in the DMATSS register.

1: One or more bits have changed in the DMATSS register.

#### • DMATSR: DMATouch State Read Register Ready

- 0: A new state word is not available in the DMATSR register.
- 1: A new state word is available in the DMATSR register.

#### • DMATSW: DMATouch State Write Register Request

0: The DMATouch algorithm is not requesting that a state word be written to the DMATSW register.

1: The DMATouch algorithm is requesting that a state word be written to the DMATSW register.

#### • ACQDONE: Acquisition Done

- 0: Acquisition is not done (still in progress).
- 1: Acquisition is complete.

#### • ACREADY: Acquired Count Data is Ready

0: Acquired count data is not available in the ACOUNT register.

1: Acquired count data is available in the ACOUNT register.

#### • MBLREQ: Matrix Burst Length Required

- 0: The QMatrix acquisition does not require any burst lengths.
- 1: The QMatrix acquisition requires burst lengths for the current X line.

# ATSTATE: Autonomous Touch Sensor State

- 0: The autonomous QTouch sensor is not active.
- 1: The autonomous QTouch sensor is active.

#### **ATSC: Autonomous Touch Sensor Status Interrupt**

- 0: No status change in the autonomous QTouch sensor.
- 1: Status change in the autonomous QTouch sensor.



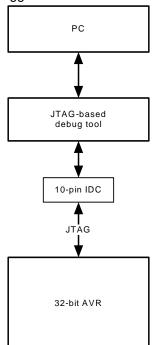
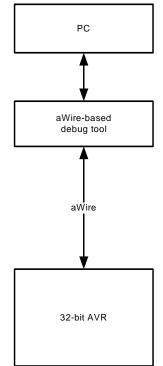


Figure 34-3. aWire-based Debugger



# 34.3.6.1 Debug Communication Channel

The Debug Communication Channel (DCC) consists of a pair OCD registers with associated handshake logic, accessible to both CPU and debugger. The registers can be used to exchange data between the CPU and the debugmaster, both runtime as well as in debug mode.



- 1. The size of the data field: 7 (size and starting address + read length indicator) in the length field.
- 2. The size of the transfer: Words, halfwords, or bytes.
- 3. The starting address of the transfer.
- 4. The number of **bytes** to read (max 65532).

The 4 MSB of the 36 bit SAB address are submitted together with the size field (2 bits). The 4 remaining address bytes are submitted before the number of bytes to read. The size of the transfer is specified using the values from the following table:

#### Table 34-43. Size Field Decoding

Size field	Description
00	Byte transfer
01	Halfword transfer
10	Word transfer
11	Reserved

Below is an example read command:

- 1. 0x55 (sync)
- 2. 0x81 (command)
- 3. 0x00 (length MSB)
- 4. 0x07 (length LSB)
- 5. 0x25 (size and address MSB, the two MSB of this byte are unused and set to zero)
- 6. 0x00
- 7. 0x00
- 8. 0x00
- 9. 0x04 (address LSB)
- 10. 0x00
- 11. 0x04
- 12. 0xXX (CRC MSB)
- 13. 0xXX (CRC LSB)

The length field is set to 0x0007 because there are 7 bytes of additional data: 5 bytes of address and size and 2 bytes with the number of bytes to read. The address and size field indicates one word (four bytes) should be read from address 0x500000004.

Table 34-44.	MEMORY_	_READ Details
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Atmel

Command	Details
Command value	0x81
Additional data	Size, Address and Length
Possible responses	0xC1: MEMDATA (Section 34.6.8.4) 0xC2: MEMORY_READWRITE_STATUS (Section 34.6.8.5) 0x41: NACK (Section 34.6.8.2)

# 35.6.2 32 KHz Crystal Oscillator (OSC32K) Characteristics

Figure 35-3 and the equation above also applies to the 32KHz oscillator connection. The user must choose a crystal oscillator where the crystal load capacitance  $C_L$  is within the range given in the table. The exact value of  $C_L$  can then be found in the crystal datasheet.

Table 35-12. 32 KHz Crystal Oscillator Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f <sub>OUT</sub>	Crystal oscillator frequency			32 768		Hz
t <sub>STARTUP</sub>	Startup time	$R_{S} = 60$ kOhm, $C_{L} = 9$ pF		30 000 <sup>(1)</sup>		cycles
CL	Crystal load capacitance <sup>(2)</sup>		6		12.5	
C <sub>i</sub>	Internal equivalent load capacitance			2		pF
I <sub>OSC32</sub>	Current consumption			0.6		μA
R <sub>S</sub>	Equivalent series resistance <sup>(2)</sup>	32 768Hz	35		85	kOhm

Notes: 1. Nominal crystal cycles.

2. These values are based on simulation and characterization of other AVR microcontrollers manufactured in the same process technology. These values are not covered by test limits in production.

## 35.6.3 Phase Locked Loop (PLL) Characteristics

Table 35-13. Phase Locked Loop Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f <sub>OUT</sub>	Output frequency <sup>(1)</sup>		40		240	MHz
f <sub>IN</sub>	Input frequency <sup>(1)</sup>		4		16	IVITIZ
I <sub>PLL</sub>	Current consumption			8		µA/MHz
	Startup time, from enabling	f <sub>IN</sub> = 4MHz		200		
t <sub>STARTUP</sub>	the PLL until the PLL is locked	f <sub>IN</sub> = 16MHz		155		μs

Note: 1. These values are based on simulation and characterization of other AVR microcontrollers manufactured in the same process technology. These values are not covered by test limits in production.